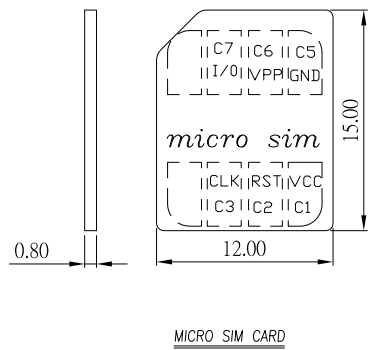
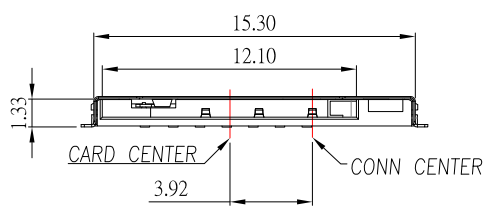
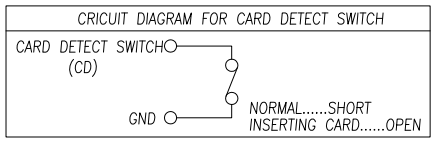


PCB LAYOYT



SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

- Material:**
- Housing: LCP
 - Contact: Copper Alloy
 - Shell: SUS
- Finish:**
- Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
 - Shell: Nickel under Plated surface laye



TOLERANCE UNLESS OTHERWISE STATED :

Up to 5	±0.2
Above 5 ~ 15	±0.3
Above 15 ~ 30	±0.4
Above 30 ~ 50	±0.5
Angle	±0.3°

3RD. ANGEL'S



ITEM NO.	DESCRIPTION	DRAWN	DATE
3	更新樣式	Jack	102820
2	更新尺寸	Jack	101518
1	更新樣式	Jack	101218

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	10/28/20		MODLE	MICRO SIM CARD PUSH PUSH 7PIN
CHECKED BY:	DATE	FINISH	SCALE	1.45H 帶CD PIN(防呆型)
Jacky Chen	10/28/20		DWG NO.	MSIM-S3071-A1-S304
APPROVED BY:	DATE	SHEET NO.	PART NO.	MSIM-S3071-A1-S304
Tony Kao	10/28/20	1 of 1		

SIZE	A4
VER	R3